



Click [here](#) for the 3D model.

General Information

| | |
|----------------|--|
| Series | Array Auto COG Flex |
| Style | SMD Array |
| Description | SMD, MLCC, Array, Flex Termination, Automotive Grade |
| Features | Automotive Grade |
| RoHS | Yes |
| Termination | Flexible Termination |
| Qualifications | AEC-Q200 |
| AEC-Q200 | Yes |
| Chip Size | 0612 |
| MSL | 1 |

Dimensions

| | |
|---|-----------------|
| L | 1.6mm +/-0.2mm |
| W | 3.2mm +/-0.2mm |
| T | 0.8mm +/-0.10mm |
| P | 0.8mm +/-0.10mm |

Packaging Specifications

| | |
|--------------------|------------------------|
| Packaging | T&R, 180mm, Paper Tape |
| Packaging Quantity | 4000 |

Specifications

| | |
|-----------------------|--------------------|
| Capacitance | 100 pF |
| Tolerance | 20% |
| Voltage DC | 100 VDC |
| Temperature Range | -55/+125°C |
| Temp. Coefficient | COG |
| Dissipation Factor | 0.1% 1 MHz 1.0Vrms |
| Insulation Resistance | 100 GOhms |

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.